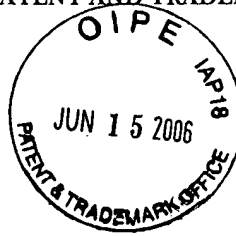


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



IN RE THE APPLICATION OF: T. Saeiki, et al.

SERIAL NO.: 10/632,844

FILED: August 4, 2003

TITLE: Injection Molding Method And Injection Molding Apparatus

GROUP: 1732

EXAMINER: M. Huson

COMMISSIONER FOR PATENTS

P.O. Box 1450

Alexandria, VA 22313-1450

SIR:

TRANSMITTED HERewith IS AN [X] AMENDMENT, [] REPLY, [] AMENDMENT AFTER FINAL REJECTION IN THE ABOVE-IDENTIFIED APPLICATION.

[] Small entity status of this application under 37 C.F.R. 1.9 and 1.27 has been established by a verified statement previously submitted.

[] A verified statement to establish small entity status under 37 C.F.R. 1.9 and 1.27 is enclosed.

[X] No additional fee is required.

THE FEE HAS BEEN CALCULATED AS SHOWN BELOW:

CLAIMS	REMAINING AFTER AMENDMENT		HIGH.# PREV. PAID FOR	PRESENT EXTRA	SMALL ENTITY RATE ADD'L FEE	OTHER THAN A SMALL ENTITY RATE ADD'L FEE
TOTAL	9	MINUS	20	- 0	X9-\$	X18-\$0
INDEP.	3	MINUS	7	- 0	X40-\$	X80-\$0

[] FIRST PRESENTATION OF MULTIPLE DEPENDENT CLAIM		+140-\$	+280-\$
	TOTAL ADD'L FEE		-0-

[X] The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 20-1424. A duplicate copy of this sheet is attached.

X Any additional filing fees under 37 C.F.R. 1.16 for the presentation of extra claims.

X Any patent application processing fees under 37 C.F.R. 1.17.

X Any extensions of time under 37 C.F.R. 1.17.

[] Please charge my deposit account No. 20-1424 in the amount of \$

[] A check in the amount \$ -0- is attached.

Date: June 12, 2006

Donald E. Townsend, Jr.
Attorney of Record
Registration No. 43,198

TOWNSEND & BANTA
Suite 900, South Building
601 Pennsylvania Ave., N.W.
Washington, D.C. 20004
(202) 220-3124



DOCKET NO.: SUG-017-USA-PCT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
T. Saeki, et al.

Serial No.: **10/632,844**

Art Unit: **1732**

Filed: **August 4, 2003**

Examiner: **M. Huson**

For: **Injection Molding Method And Injection Molding Apparatus**

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Responsive to the official Office Action mailed January 12, 2006, (the response to which having been extended by virtue of a petition under 37 C.F.R. 1.136(a) and requisite fee filed herewith), in the matter of the above-identified application, kindly amend the same as follows: